

Yuzhe Fu

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EDUCATION

Peking University – Beijing, China

September 2021 – June 2024

Master in Microelectronics and Solid-State Electronics

- GPA: 3.59 / 4.0
- Supervisor: Prof. Hailong Jiao

University of California, Berkeley – Berkeley, USA

August 2019 – December 2019

Semester Exchange, Global Access Program

- GPA: 3.94 / 4.0

Southern University of Science and Technology – Shenzhen, China

September 2017 – June 2021

Bachelor of Microelectronics Science and Engineering

- GPA: 3.88 / 4.0, **1st in Comprehensive Ranking**
- Supervisor: Prof. Fengwei An

RESEARCH INTERESTS

- Algorithm-hardware co-design
- Energy-efficient and configurable artificial intelligence accelerator design

PUBLICATIONS

- **Y. Fu**, C. Zhou, T. Huang, E. Han, Y. He, and H. Jiao, "SoftAct: A High-Precision Softmax Architecture for Transformers with Nonlinear Functions Support," *IEEE Transactions on Circuits and Systems I: Regular Papers (TCAS-I)*, 2023. (Under review)
- C. Zhou#, **Y. Fu**#, Y. Ma, E. Han, Y. He, and H. Jiao, "An Adjustable Multi-Stream Block-Wise Farthest Point Sampling Acceleration Framework," *IEEE Transactions on Circuits and Systems II: Express Briefs (TCAS-II)*, 2023. (# Authors with equal contribution, plan to submit in September)
- C. Zhou, **Y. Fu**, M. Liu, S. Qiu, G. Li, Y. He, and H. Jiao, "An Energy-Efficient 3D Point Cloud Neural Network Accelerator with Efficient Filter Pruning, MLP Fusion, and Dual-Stream Sampling," *IEEE/ACM International Conference on Computer Aided Design (ICCAD)*, 2023. (Accepted)
- C. Zhou, M. Liu, S. Qiu, X. Cao, **Y. Fu**, Y. He, and H. Jiao, "Sagitta: An Energy-Efficient Sparse 3D-CNN Accelerator for Real-Time 3D Understanding," *IEEE Internet of Things Journal (IoT-J)*, 2023.
- P. Dong, Z. Chen, Z. Li, **Y. Fu**, L. Chen, F. An, "A 4.29nJ/pixel Stereo-depth Coprocessor with Pixel-level Pipeline and Region-Optimized Semi-Global Matching for IoT Application," *IEEE Transactions on Circuits and Systems I: Regular Papers (TCAS-I)*, 2021.

PATENT

- F. An, **Y. Fu**, P. Dong, Z. Chen, Z. Li, "Low-power-consumption stereo matching system and method for acquiring depth information," *CN Patent*, 2020, CN112070821A / WO2022021912A1.

HONORS & AWARDS

- Best Presentation Award, IEEE CASS Shanghai and Shenzhen Joint Workshop, 2021
- **China National Scholarship (Top 8 in SUSTech)**, Ministry of Education of the PRC, 2020
- First Class Scholarship (**Top 5% in SUSTech**), Southern University of Science and Technology, 2019
- First Class Scholarship (**Top 5% in SUSTech**), Southern University of Science and Technology, 2018

PROJECT EXPERIENCE

SoftAct: A High-Precision Softmax Architecture for Transformers Supporting Nonlinear Functions

Project Leader

July 2022 – Present

- Developed an improved softmax with penalties and optimized precision up to 359×.
- Introduced a full-zero-detection method and designed a compact and reconfigurable architecture.
- Implemented in TSMC 28nm technology and benchmarked with the MobileViT network, improving up to 35.14% network accuracy, 10× maximum frequency, and 809× overall efficiency.

Nebula: An Energy-Efficient 3D Point Cloud-Based Neural Network Accelerator

Main Contributor & Module Leader

February 2022 – Present

- Responsible for software work (model training, quantization and pruning, algorithm verification, etc.).
- Proposed a novel FPS accelerating unit, ensuring precision while mitigating complexity by 14.22×. Further developed a multi-stream FPS method, mitigating complexity by 786.4×.
- Co-designed a block-wise MLP fusion dataflow scheme, reducing the memory access by 21.1×.

Sagitta: An Energy-Efficient Sparse 3D-CNN Accelerator for Real-Time 3D Understanding

Contributor

December 2021 – December 2022

- Responsible for pruning and extraction of network data for analysis.
- Leveraged locality and small differential value dropout to increase the sparsity of activations.

SGM Accelerator: A 4.29nJ/pixel Stereo-depth Coprocessor with Pixel-level Pipeline and Region-Optimized Semi-Global Matching for IoT Application

Project Leader

February 2020 – June 2021

- Proposed a region-optimized stereo matching strategy improving the speed of traditional semi-global matching algorithm by 5× while ensuring the accuracy.
- Proposed a four-layer parallel pipeline hardware architecture and implemented it on FPGA platform which can extract depth information in real-time at 156 MHz and 508 fps under VGA resolution.

TAPE OUT

- An energy-efficient pipelined and configurable 3D point cloud-based neural network accelerator is being designed in TSMC 28-nm HPC technology with an area of 2.0 mm×1.5 mm and is taped out in July 2023.
- A 4.5 TOPS/W sparse 3D-CNN accelerator for real-time 3D understanding was fabricated in UMC 55-nm low-power CMOS technology with an area of 4.2 mm×3.6 mm in August 2020.

SKILLS

- Proficient in digital integrated circuit (IC) front-end development (RTL implementation and logic synthesis), FPGA development, and neural network model compression.
- Familiar tools: Cadence (Genus and NCSim), Vivado; PyTorch, Intel Distiller (model compression).
- Knowledgeable languages: Verilog HDL, Python, JAVA, MATLAB, Shell, Makefile.
- For additional information, please visit my website: <https://yuzhe-fu.github.io>